# MBRB2545CTG, SBRB2545CTG

# Schottky Power Rectifier, Switch-Mode, 30 A, 45 V

The D<sup>2</sup>PAK Power Rectifier is a stat6-the-art device that employs the Schottky Barrier principle with a platinum barrier metal.

### Features

- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 175°C Operating Junction Temperature
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Short Heat Sink Tab Manufactured Not Sheared
- Similar in Size to the Industry Standard TO-220 Package
- AEC-Q101 Qualified and PPAP Capable
- SBRB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- All Packages are Pb-Free\*

### **Mechanical Characteristics**

- Case: Epoxy, Molded, Epoxy Meets UL 94 V-0
- Weight: 1.7 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL1 Requirements
- ESD Ratings:
  - Machine Model = C (> 400 V)
  - ♦ Human Body Model = 3B (> 8000 V)



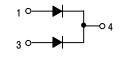
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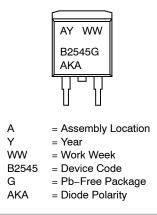
### SCHOTTKY BARRIER RECTIFIER 30 AMPERES, 45 VOLTS



CASE 418B STYLE 3



### MARKING DIAGRAM



### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

### MBRB2545CTG, SBRB2545CTG

### MAXIMUM RATINGS (Per Leg)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	V
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 164°C) Total Device	I <sub>F(AV)</sub>	15 30	A
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 160°C)	I <sub>FRM</sub>	30	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	А
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	1.0	А
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature (Note 1)	TJ	-65 to +175	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/μs

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. The heat generated must be less than the thermal conductivity from Junction-to-Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .

### THERMAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Value	Unit
Thermal Resistance,			°C/W
Junction-to-Case	$R_{\theta JC}$	1.5	
Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	50	

2. When mounted using minimum recommended pad size on FR-4 board.

### ELECTRICAL CHARACTERISTICS (Per Diode)

Symbol	Characteristic	Condition	Min	Тур	Max	Unit
V <sub>F</sub>	Instantaneous Forward Voltage (Note 3)	$ I_{F} = 15 \text{ Amp, } T_{J} = 25^{\circ}\text{C} $ $ I_{F} = 15 \text{ Amp, } T_{J} = 125^{\circ}\text{C} $ $ I_{F} = 30 \text{ Amp, } T_{J} = 25^{\circ}\text{C} $ $ I_{F} = 30 \text{ Amp, } T_{J} = 125^{\circ}\text{C} $		_ 0.50 _ 0.65	0.62 0.57 0.82 0.72	V
I <sub>R</sub>	Instantaneous Reverse Current (Note 3)	$V_R$ = 45 Volts, $T_J$ = 25°C $V_R$ = 45 Volts, $T_J$ = 125°C		_ 9.0	0.2 25	mA

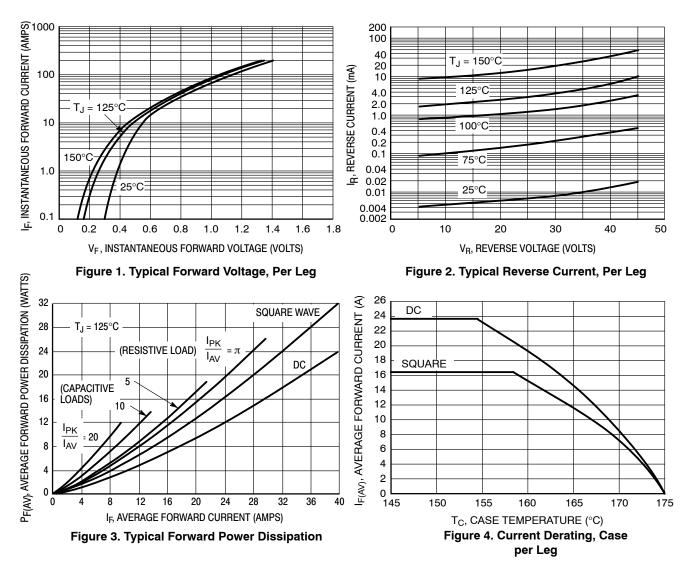
3. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

### **ORDERING INFORMATION**

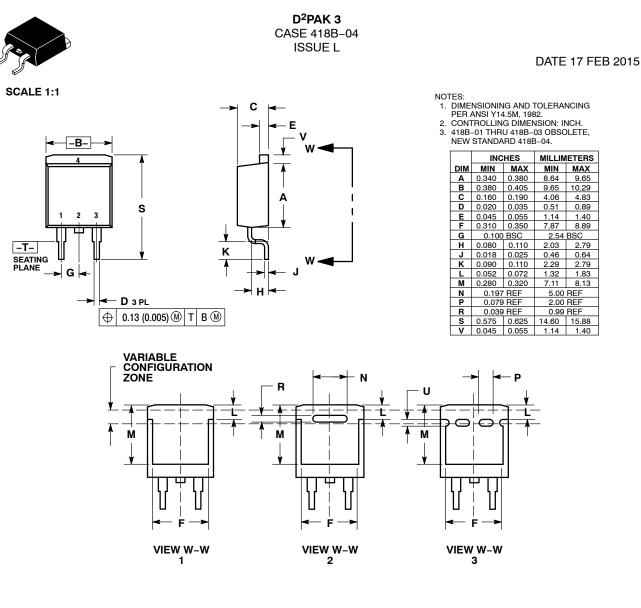
Device	Package	Shipping <sup>†</sup>
MBRB2545CTG	D <sup>2</sup> PAK (Pb–Free)	50 Units / Rail
SBRB2545CTG	D <sup>2</sup> PAK (Pb–Free)	50 Units / Rail
MBRB2545CTT4G	D <sup>2</sup> PAK (Pb–Free)	800 Units / Tape & Reel
SBRB2545CTT4G	D <sup>2</sup> PAK (Pb–Free)	800 Units / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## MBRB2545CTG, SBRB2545CTG







STYLE 1:	STYLE 2:	STYLE 3:	STYLE 4:	STYLE 5:	STYLE 6:
PIN 1. BASE	PIN 1. GATE	PIN 1. ANODE	PIN 1. GATE	PIN 1. CATHODE	PIN 1. NO CONNECT
2. COLLECTOR	2. DRAIN	2. CATHODE	2. COLLECTOR	2. ANODE	2. CATHODE
3. EMITTER	<ol><li>SOURCE</li></ol>	<ol><li>ANODE</li></ol>	3. EMITTER	<ol><li>CATHODE</li></ol>	3. ANODE
4. COLLECTOR	4. DRAIN	4. CATHODE	4. COLLECTOR	4. ANODE	4. CATHODE

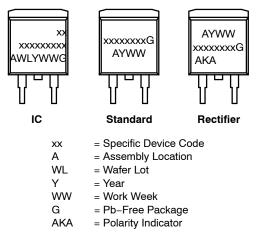
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### D<sup>2</sup>PAK 3 CASE 418B-04 ISSUE L

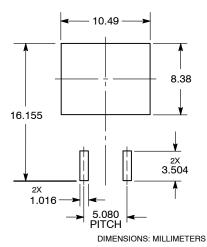
### DATE 17 FEB 2015

### GENERIC MARKING DIAGRAM\*



\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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